

GMEMS Technologies (Shenzhen) Ltd.

Specifications of Analog Silicon Microphone

GTM2718AB381-PW0

Rev 1.2

(RoHS Compliant & Halogen Free)

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Approvals				

1. PRODUCT DESCRIPTION

GTM2718AB381-PW0 is a miniature, very high-performance, low power consumption silicon microphone with analog output and bottom-port for sound input. It is a cost-effective alternative to traditional electret condenser microphone (ECM). Provided on tap-and-reel, it is ideally suited for high volume applications. And it can be attached directly to customer's PCB using standard automatic pick-and-place equipment and surface-mounted via standard solder reflow equipment.

GTM2718AB381-PW0 is specifically designed for Cellphones that require very high SNR $\$ AOP and Great RF Immunity bottom-port sound inlet silicon microphones, although it can be used for other applications.

2. APPLICATIONS:

- 1). Cellphones
- 2). Smart electronic devices
- 3) Portable electronics
- 3. FEATURES
- ➢ 2.75×1.85×0.95mm Bottom-port Package
- Sensitivity of $-38(\pm 1)$ dBV/Pa
- SNR of 66dB(A)
- Low Power Consumption
- Very Flat Frequency Response

- High Reliability
- ➢ Great RF Immunity
- Lead-free Reflow Process Compatible
- Omni-directional
- Ultra-stable Performance

4. ABSOLUTE MAXIMUM RATINGS

Supply Voltage: VDD to GND- $0.3V \sim 5V$

ESD Tolerance

The Lid Mode8kV

The I/O Pin Mode4kV

TEMPERATURE CHARACTERISTICS					
Parameter	Conditions	Min	Тур	Max	Unit
Operating Temperature		-40		+85	°C
Store on Terminerations	Solder on PC board	-40		+105	°C
Storage Temperature	In Tape and Reel	-10		+50	°C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

5. ACOUSTIC & ELECTRICAL SPECIFICATIONS

Test Conditions:

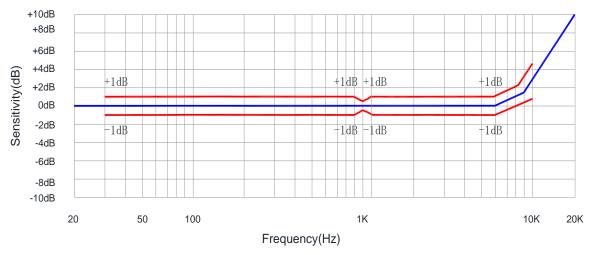
Ta = 25°C, R.H. = 50 \pm 20%, V_{DD} = 2.0V, Input sound pressure P_{IN} = 94dB SPL@1kHz

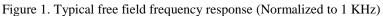
SNR & noise floor measurement is based on 100Hz ~ 10KHz passband with A-Weighting filter applied unless specifically specified in the table below.

Parameter	Conditions	Min	Тур	Max	Unit	
Directivity			Omni-Directional			
Power Supply Voltage		1.5	-	3.3	V	
Sensitivity	@1KHz (0 dB = 1V/Pa)	-39	-38	-37	dBV/Pa	
Signal-to-Noise Ratio (SNR)	@1KHz (0 dB = 1V/Pa) (100Hz ~ 10KHz)	64	66	-	dB(A)	
Signal-to-Noise Ratio (SNR)	@1KHz (0 dB = 1V/Pa) (20Hz ~ 20KHz)	63	65	-	dB(A)	
Total Harmonic Distortion (THD)	@100dB SPL @1KHz	-	0.2	-	%	
Acoustic Overload Point (AOP)	@1KHz, THD < 10%	-	130	-	dB SPL	
Power Supply Rejection (PSR)	217Hz, 100mVpp square wave	-	-90	-	dB	
Sensitivity Loss Across Power Supply Voltage	Change in sensitivity from 1.5V to 3.3V power supply voltage	No change dB		dB		
Total Operation Current	1.5V~3.3V power supply voltage	95	115	130	uA	
Output Impedance	@1KHz (0dB=1V/Pa)	-	-	200	Ω	

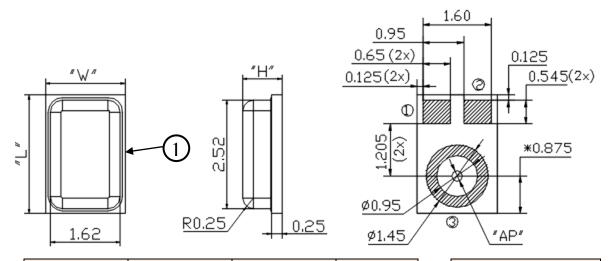


6. FREQUENCY RESPONSE CURVE





7. MECHANICAL SPECIFICATIONS



TTEL	DIMENSION	TOLEDANCE	LINITO		PIN OUTPUT	
ITEM	DIMENSION	TOLERANCE	TOLERANCE UNITS		PIN#	FUNCTION
LENGTH(L)	2.75	±0.10	mm		1	VDD
WIDTH(W)	1.85	±0.10	mm		2	OUTPUT
HEIGHT(H)	0.95	±0.10	mm		3	GND
ACOUSTIC PORT(AP)	Ф0.25	±0.10	mm			

Note: Dimensions are in millimeters unless otherwise specified. Tolerance ± 0.15 mm unless otherwise specified

Figure 2. Detailed mechanical drawings



8. RECOMMENDED CUSTOMER LANDING PATTERN

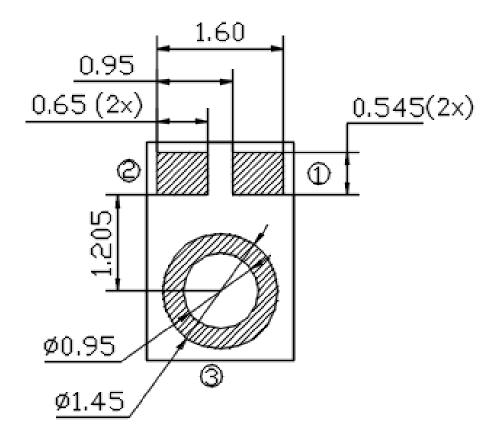
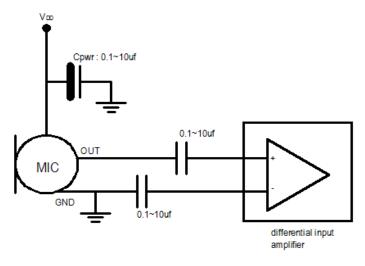
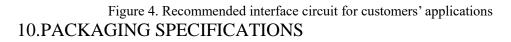


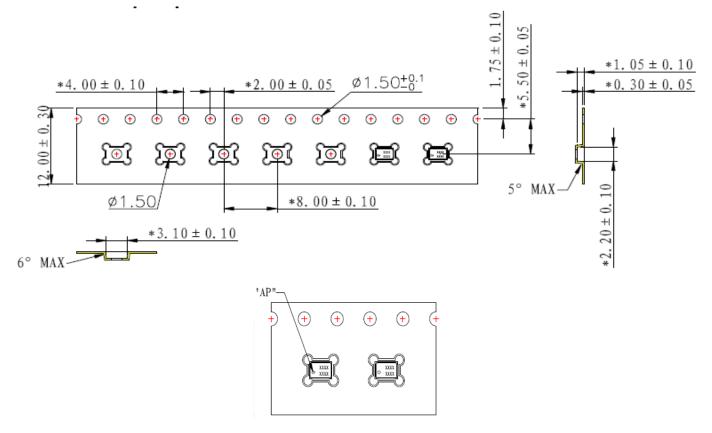
Figure 3. Recommended landing pattern on customers' PCB

9. RECOMMENDED INTERFACE CIRCUIT









Notes:

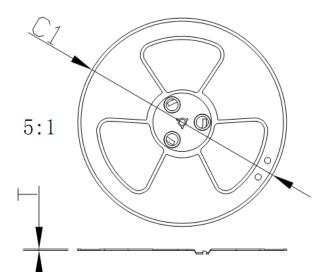
- (1) Dimensions are in millimeters unless otherwise specified;
- (2) Tape & Reel Per EIA-481 standard;
- (3) Label applied to external package and direct to reel;
- (4) Shelf life: Twelve (12) months when devices are to be stored in factory supplied, unopened ESD moisture sensitive bag under maximum environmental conditions of 30°C, 70% R.H.

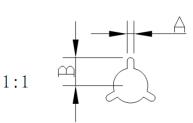
Order Part Number	Reel Diameter	Qty per Reel	
GTM2718AB381-PW0	13"	5,000	

Figure 5. Tape Specification



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13"

Φ330

2.6

10.8

2.0

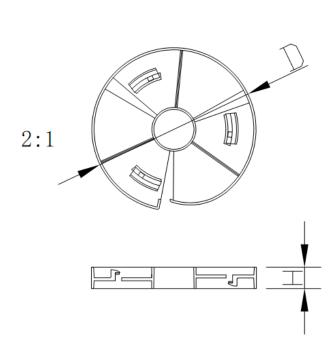
SPEC

 $C1 \pm 1.0$

 $A\pm0.2$

 $B\pm0.2$

 $T\pm0.2$

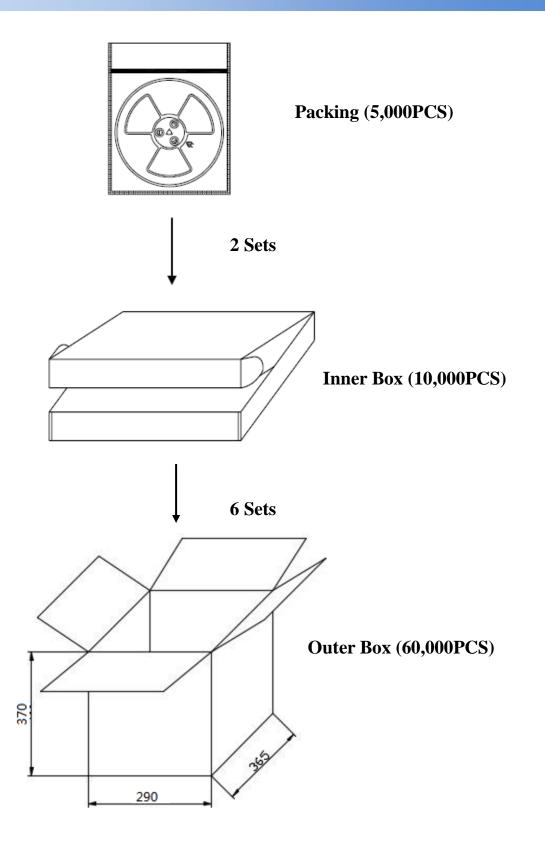


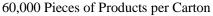
Avaliable Reel Size(mm)Tape Width $D \pm 0.5$ H+112 $\Phi 100$ 12.5

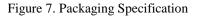
5,000 Pieces of Products per Reel

Figure 6. Reel Specification



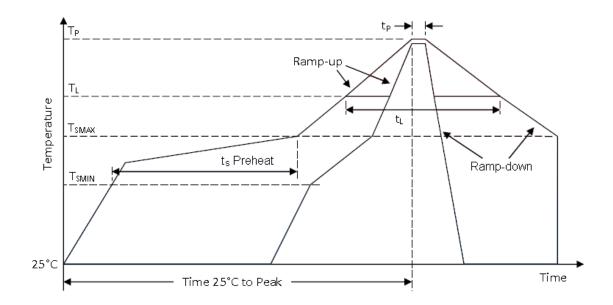








11.SOLDER REFLOW PROFILE



Profile Feature	Pb-Free
Average Ramp-up Rate $(T_{SMAX} \text{ to } T_P)$	3°C/second max.
Preheat	
Temperature Min (T _{SMIN})	150°C
Temperature Max (T _{SMAX})	200°C
Time $(T_{SMIN} \text{ to } T_{SMAX}) (t_S)$	60-180 seconds
Time maintained above:	
Temperature (T _L)	217°C
Time (t_L)	60-150 seconds
Peak Temperature (T _P)	260°C
Time within 5°C of actual Peak Temperature (t _P)	20-40 seconds
Ramp-down Rate(T _P to T _{SMAX})	6°C/second max
Time 25°C to Peak Temperature	8 minutes max

Figure 8. Recommended leadless solder reflow temperature profile

Notes:

- 1. Vacuuming over acoustical hole of the microphone is not allowed, because the device can be damaged by vacuum.
- 2. Washing the board after reflow process is not allowed, because board washing and cleaning agents can damage the device. A device should not be exposed to ultrasonic processing or cleaning.
- 3. Recommended number of reflow is no more than 5 times.
- 4. Do not apply over 30 psi of air pressure into the port hole.
- 5. MSL (moisture sensitivity level) Class 1.



12.RELIABILITY SPECIFICATIONS

Test item	Detail	Standard
Reflow Simulation	Refer to Sec.9 for solder reflow profile, total 5 times	/
Low Temperature Bias	Conditions: -40°C Duration:168 hours while under bias	IEC 60068-2-2 Test Aa
High Temperature Bias	Conditions: 105°C Duration:168 hours while under bias	IEC 60068-2-2 Test Ba
Thermal Shock	Conditions: 100 cycles of air-air thermal shock from -40°C to 125°C with 15-minute soaks	IEC 60068-2-4
Temperature/Humidity Bias	Conditions: 85°C/85%RH environment while under bias for 168 hours	JESD 22-A101A-B
Mechanical Shock	Conditions:3 pulses of 10,000g in the X,Y and Z direction	IEC 60068-2-27 Test Ea
Vibration Test	Test axis: X,Y,Z Conditions: 2~400Hz 1 oct/min Test time: 15 mins per axis Use fixture during the testing	IEC 60068-2-6
Drop Test	Conditions: For each sample, drop by all corners, edges, surfaces respectively. Steel floor. Drop height: 1800mm.	IEC 60068-2-32
ESD	Conditions: ±8KV direct contact to the lid when unit is grounded, ±4KV direct contact to the I/O pins.10 times	IEC 61000-4-2

Note:

Immediately after reliability test, the samples shall be stored under climatic conditions such as that normally exist in ordinary rooms or laboratories. Unless otherwise noted, the recovery period shall be 2 hours at least before performance testing. After test condition is performed, the sensitivity of the microphone shall not deviate more than 3dB from its initial value.

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13.REVISION HISTORY:

Version	Date	Description
1.0	16/7/2020	Initial release
1.1	10/11/2020	SNR Change
1.2	5/10/2021	Change the format

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